**SDLS186** 

D2501, JANUARY 1980 - REVISED MARCH 1988

- Separate Supply Voltage Pins for Isolation of Frequency Control Inputs and Oscillators from Output Circuitry
- Highly Stable Operation over Specified Temperature and/or Supply Voltage Ranges

	DEVICE TYPE	SIMILAR TO	NUMBER VCO's	COMP'L Z OUT	ENABLE	RANGE INPUT	Rext
	'L\$624	'LS324	single	yeş	yes	yes	ΠQ
ı	'LS625	'L\$325	dual	yes	no	no	ΠQ
	'LS626	'LS326	dual	yes	yes	no	no.
J	'L\$627	'LS327	dual	no	no	no	no
١	'LS628	'L\$324	single	γes	yes	yes	yes
L	'LS629	'LS124	dual	no	yes	γes	no

### description

These voltage-controlled oscillators (VCOs) are improved versions of the original VCO family: SN54LS124, SN54LS324 thru SN54LS327, SN74LS124, and SN74LS324 thru SN74LS327. These new devices feature improved voltage-to-frequency linearity, range, and compensation. With the exception of the 'LS624 and 'LS628, all of these devices feature two independent VCOs in a single monolithic chip. The 'LS624, 'LS625, 'LS626, and 'LS628 have complementary Z outputs. The output frequency for each VCO is established by a single external component (either a capacitor or crystal) in combination with voltage-sensitive inputs used for frequency control and frequency range. Each device has a voltage-sensitive input for frequency control; however, the 'LS624, 'LS628, and 'LS629 devices also have one for frequency range. (See Figures 1 thru 6).

The 'LS628 offers more precise temperature compensation than its 'LS624 counterpart. The 'LS624 features a 600 ohm internal timing resistor. The 'LS628 requires a timing resistor to be connected externally across R<sub>ext</sub> pins. Temperature compensation will be improved dur to the temperature coefficient of the external resistor.

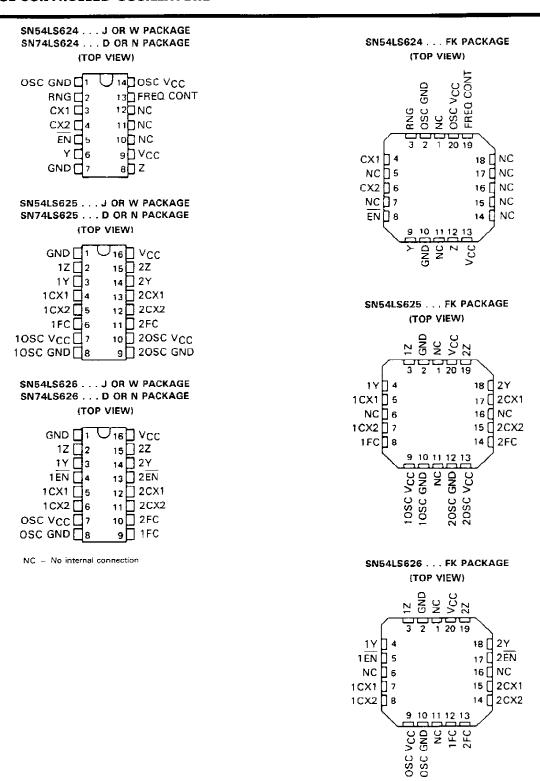
Figure 3 and Figure 6 contain the necessary information to choose the proper capacitor value to obtain the desired operating frequency.

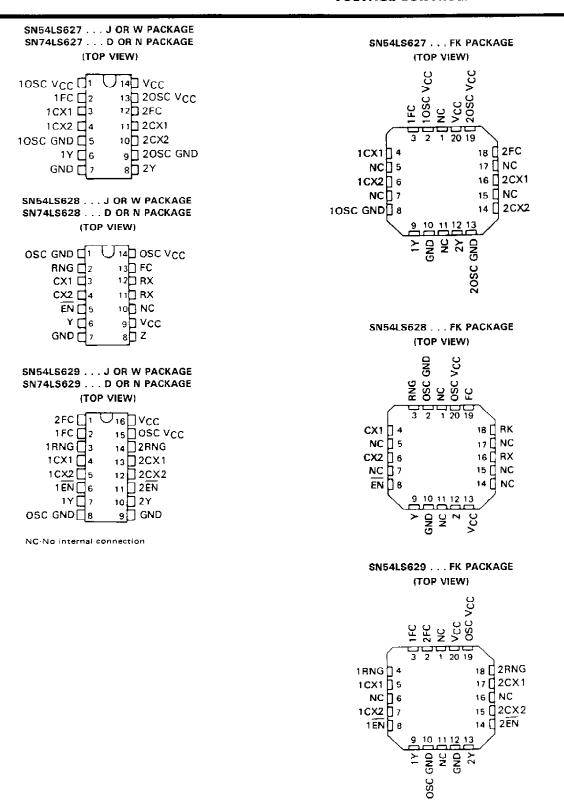
A single 5-volt supply can be used: however, one set of supply voltage and ground pins (V<sub>CC</sub> and GND) is provided for the enable, synchronization-gating, and output sections, and a separate set (OSC V<sub>CC</sub> and OSC GND) is provided for the oscillator and associated frequency-control circuits so that effective isolation can be accomplished in the system. For operation of frequencies greater than 10 MHz, it is recommended that two independent supplies be used. Disabling either VCO of the 'LS625 and 'LS625 and 'LS627 can be achieved by removing the appropriate OSC V<sub>CC</sub>. An enable input is provided on the 'LS624, 'LS626, 'LS628, and 'LS629. When the enable input is low, the output is enabled: when the enable input is high, the internal oscillator is disabled, Y is high, and Z is low. Caution! Crosstalk may occur in the dual devices ('LS625, 'LS626, 'LS627 and 'LS629) when both VCOs are operated simultaneously. To minimize crosstalk, either of the following are recommended: (A) If frequencies are widely separated, use a 10-µh inductor between V<sub>CC</sub> pins. (B) If frequencies are closely spaced, use two separate V<sub>CC</sub> supplies or place two series diodes between the V<sub>CC</sub> pins.

The pulse-synchronization-gating section ensures that the first output pulse is neither clipped nor extended. The duty cycle of the square-wave output is fixed at approximately 50 percent.

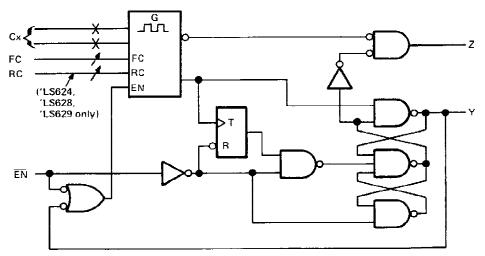
The SN54LS624 thru SN54LS629 are characterized for operation over the full military temperature range of -55 °C to 125 °C. The SN74LS624 thru SN74LS629 are characterized for operation from 0 °C to 70 °C.



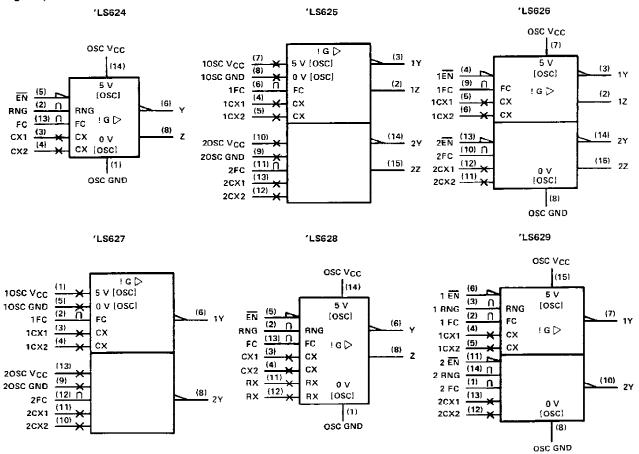




# logic diagram (positive logic)



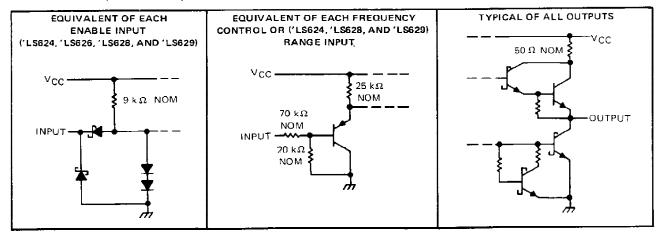
## logic symbols †



 $<sup>^{\</sup>dagger}$ These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.



# schematics of inputs and outputs



# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Notes 1 and 2)		 	 	 	 	7 🗸
Input voltage: Enable input †		 	 	 	 	7 V
Frequency control or range input #		 	 	 	 	· · · · V <sub>CC</sub>
Operating free-air temperature range: SN54LS' Ci	rcuits	 	 	 	 	−55°C to 125°C
SN74LS' Cit	rcuits	 	 	 	 	, 0°C to 70°C
Storage temperature range		 	 	 	 	−65°C to 150°C

<sup>†</sup> The enable input is provided only on the 'LS624, 'LS626, 'LS628, and 'LS629.

- NOTE: 1. Voltage values are with respect to the appropriate ground terminal.
  - 2. Throughout the data sheet, the symbol  $V_{CC}$  is used for the voltage applied to both the  $V_{CC}$  and OSC  $V_{CC}$  terminals, unless otherwise noted.

<sup>‡</sup> The range input is provided only on 'LS624, 'LS628, and 'LS629.

# SN54LS624 THRU SN54LS629, SN74LS624 THRU SN74LS629 VOLTAGE-CONTROLLED OSCILLATORS

## recommended operating conditions

	, ,	SN74LS'			דומט		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, VCC	4.5	5	5.5	4.75	5	5,25	٧
Input voltage at frequency control or range input, V <sub>I(freq)</sub> or V <sub>I(rng)</sub>	. 0		5	0		5	V
High-level output current, IOH			-1.2	-		-1.2	mA
Low-level output current, IOL			12			24	mΑ
Dutaut francisco I	1	-		1		_	Hz
Output frequency, fo			20			20	MHz
Operating free-air temperature, TA	-56		125	0		70	³ C

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†			Ī	SN54LS	S'		UNIT			
	FANAIVIE	IEM	1631	- CONDITIONS			TYPT	MAX	MIN	TYP	MAX	UNIT	
Vін	High-level inpu voltage at ena				<del>-</del>	2			2			٧	
VIL	Low-level input  VIL voltage at enable#							0.7			0.8	٧	
Vικ	/IK Input clamp voltage at enable# VCC = MIN, II = -18 mA							-1.5			-1.5	V	
∨он	High-level outp	ut voltage	V <sub>CC</sub> = MIN, I <sub>OH</sub> = -1.2 mA,	! <del>=</del>			3,4		2.7	3.4		V	
Vai	Low-level outp		VCC = MIN,		IOL = 12 mA		0.25	0.4		0.25	0.4		
VOL.	Low-level outp	lut voitage	EN at VIL max,	See Note 3	IOL = 24 mA					0.35	0.5	٧	
П	Input current i	Freq control or range¶	Vcc ≃ MAX		V <sub>I</sub> = 5 V		50	250	-	50	250		
''			ACC - MAY		V <sub>1</sub> = 1 V		10	50		10	50	μΑ	
l j	Input current at maximum input voltage	Enable#	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V				0.2			0.2	mA	
۱н	High-level	Enable#	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V			•	40			40	μΑ	
ЦL	Low-level input current	Enable#	Vcc ≈ MAX,	V <sub>I</sub> = 0.4 V				-0.8			-0.8	mA	
IOS	Short-circuit or	stput current §	VCC ≈ MAX			-40		-225	40		-225	mA	
	VCC and OSC VCC pins				'LS624		20	35		20	35		
			VCC = MAX,		'LS625		35	55		35	55		
ton			irrent, total into Enable # = 4.5 V		'L\$626		35	55		35	55	mA	
100					'LS627	i	35	55		35	55		
					'LS628		20	35		20	35	]	
							35	55		35	55		

<sup>&</sup>lt;sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



<sup>&</sup>lt;sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25 °C.

Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

The range input is provided only on the 'LS624, 'LS628, and 'LS629.

<sup>\*</sup>The enable input is provided only on the 'LS624, 'LS626, 'LS628, and 'IS629.

NOTES: 3. V<sub>OH</sub> for Y outputs and V<sub>OL</sub> for Z outputs are measured while enable inputs are at V<sub>IL</sub> MAX, with individual 1-kΩ resistors connected from CX1 to V<sub>CC</sub> and from CX2 to ground. The resistor connections are reversed for testing V<sub>OH</sub> for Z outputs and V<sub>OL</sub> for Y inputs.

<sup>4.</sup> For 'LS624, 'LS628, and 'LS629,  $I_{CC}$  is measured with the outputs disabled and open. For 'LS625 and 'LS627,  $I_{CC}$  is measured with one OSC  $V_{CC} = MAX$ , and with the other OSC  $V_{CC}$  and outputs open.

# switching characteristics, $V_{CC}$ = 5 V (unless otherwise noted), $R_L$ = 667 $\Omega$ , $C_L$ = 45 pF, $T_A$ = 25 °C

	PARAMETER	TER TEST CONDITIONS		'L\$624,	'LS62	3, 'LS629	'LS625, 'LS626, 'LS627			UNIT
	ANAMETER			MIN	TYP	MAX	MIN	TYP	MAX	LIVIT
	Output frequency	C <sub>ext</sub> = 50 pF	$V_{I(freq)} = 5 V, V_{I(rng)} = 0 V$	15	20	25				
fo			$V_{1(freq)} = 1 V, V_{1(rng)} = 5 V$	1.1	1.6	2.1				MHz
0			V <sub>I(freq)</sub> = 5 V				7	9.5	12	IVIMZ
			VI(freq) = 0 V				0.9	1.2	1.5	Ìİ

# TYPICAL CHARACTERISTICS

'LS624, 'LS628, 'LS629

OUTPUT FREQUENCY

FREQUENCY-CONTROL INPUT VOLTAGE<sup>†</sup>

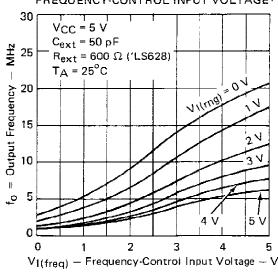


FIGURE 1

'LS624, 'LS628, 'LS629

**OUTPUT FREQUENCY** 

FREQUENCY-CONTROL INPUT VOLTAGE<sup>†</sup>

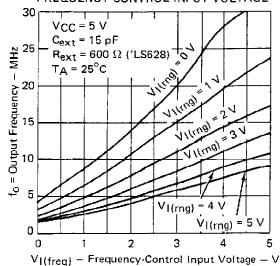


FIGURE 2

<sup>&</sup>lt;sup>†</sup> Due to the effects of stray capacitance the output frequency may be unstable when the frequency control voltage is less than 1 volt.

## TYPICAL CHARACTERISTICS

OUTPUT FREQUENCY

VS

EXTERNAL CAPACITANCE

100 M

VCC = 5 V

TA = 25°C

VIRTURAL TO M

TA = 25°C

VIRTURAL TO M

TA = 25°C

VIRTURAL TO M

TA = 25°C

'LS624, 'LS628, 'LS629

'LS625, 'LS626, 'LS627

10-11 10-10 10-9 10-8 10-7 10-6 10-5

 $C_{\mbox{ext}} - \mbox{External Capacitance} - \mbox{F}$ 

FIGURE 3

OUTPUT FREQUENCY

FREQUENCY-CONTROL INPUT VOLTAGE

30

VCC = 5 V

Cext = 15 pF

TA = 25°C

TA = 25°C

0 1 2 3 4 5

VI(freq) - Frequency-Control Input Voltage - V

FIGURE 5

'LS625, 'LS626, 'LS627 OUTPUT FREQUENCY

FREQUENCY-CONTROL INPUT VOLTAGE †

VCC = 5 V

Cext = 50 pf

7

8

TA = 25°C

10

0

1

2

3

VI(freq) - Frequency-Control Input Voltage - V

'LS625, 'LS626, 'LS627 OUTPUT FREQUENCY vs

FIGURE 4

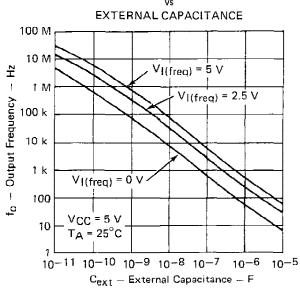
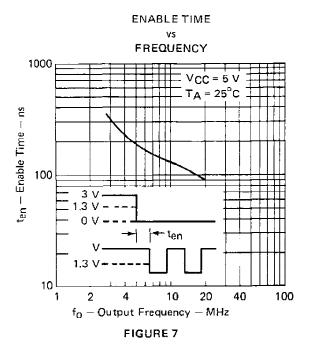


FIGURE 6

<sup>†</sup> Due to the effects of stray capacitance the output frequency may be unstable when the frequency control voltage is less than 1 volt.



# TYPICAL CHARACTERISTICS



## TYPICAL APPLICATIONS DATA

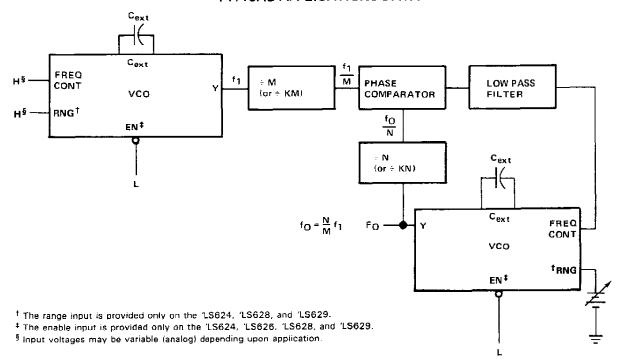


FIGURE A-PHASE-LOCKED LOOP



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